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CONFIRMATION NO. 4273

SERIAL NUMBER 10/757,752	FILING DATE 01/14/2004  RULE 1.47	CLASS 716	GROUP ART UNIT 2825	ATTORNEY DOCKET NO. 03-0171 81679
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This appln claims benefit of 60/490,715 07/28/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 04/21/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged	CA	7	25	3
Examiner's Signature <i>[Signature]</i> Initials				

## ADDRESS

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## TITLE

Optimized bond out method for flip chip wafers

FILING FEE  RECEIVED	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
		<input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )

860

☐ 1.18 Fees ( Issue )☐ Other \_\_\_\_\_☐ Credit